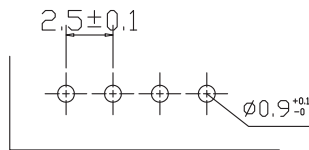
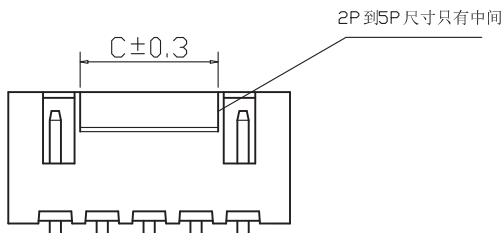
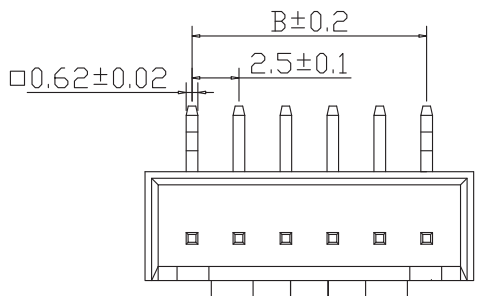
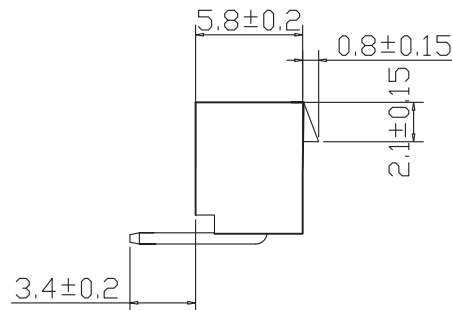
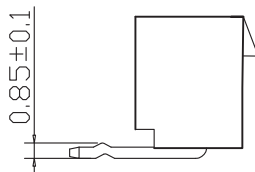
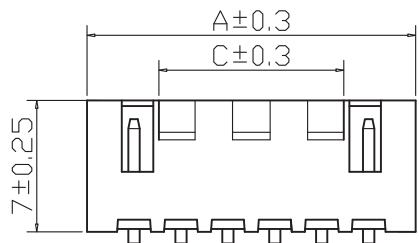


ABIDE BY ROHS



PCB LAYOUT

使用温度范围 (Ambient temperature Range):-25°~+85°

适用线规 (Applicable Wires):AWG 30#~22#

适用基板厚度 (Applicable PCboard thickness):1.6mm

额定电压 (Voltage rating):250V AC,DC

额定电流 (Current rating):3A

接触电阻 (Contact Resistance):≤0.01Ω

绝缘电阻 (Insulation Resistance):≥1000MΩ

耐压 (Withstand Voltange):1000VAC/min

材料 (Material)

1.基座: PA66 94V-0(2)

2.插针: 黄铜

孔位	A-mm	B-mm	C-mm
XHB-2AW	7.5	2.5	1.6
XHB-3AW	10.0	5.0	2.5
XHB-4AW	12.5	7.5	4.4
XHB-5AW	15.0	10.0	6.9
XHB-6AW	17.5	12.5	9.4
XHB-7AW	20.0	15.0	11.1
XHB-8AW	22.5	17.5	13.6
XHB-9AW	25.0	20.0	16.1
XHB-10AW	27.5	22.5	18.6
XHB-11AW	30.0	25.0	21.1
XHB-12AW	32.5	27.5	23.6
XHB-13AW	35.0	30.0	26.1
XHB-14AW	37.5	32.5	28.6
XHB-15AW	40.0	35.0	31.1
XHB-16AW	42.5	37.5	33.6

单位 UNIT	mm	一般公差 TOLERANCE ARE				浙江恩盛电子有限公司 Zhejiang Ensheng Electronics Co., Ltd.			
绘图 DRAWN		X.*±3° X.X*±5°				产品名称 TITLE	WAFERA针座		
设计 DESIGN		>0-3	>3-18	>18-50	>50-120				
审核 CHECKED		±0.12	±0.15	±0.3	±0.5	产品型号 MODEL	XHB-NAW		
校准化 STANDARD		图号 DRAWING NO		重量 WT.		产品编码 PART NO	ESWF-XHBWO-W-XX-C-B		
批准 APPROVALS		产地 PRODUCTION		视角 PROJ		比例 SCALE	:	页码 SHEET	1 OF 1

2		Wafer 针	Brass Tin 黄铜镀锡	N	
1		Housing 基座	PA66 94V-0(2)	1	White 白色
序号	图号	名称	材料	数量	附注

ECN NO.	A	DATE.	NEW	CHANGE.	CHECK.	APPRO.
			DESCRIPTION.			